

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)		
100	0.124 at V _{GS} = 10 V	4.2	4.6 nC		
100	0.128 at V _{GS} = 4.5 V	3.9	4.0 110		

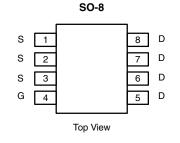
FEATURES

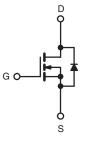
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

APPLICATIONS

- High Frequency Boost Converter
- LED Backlight for LCD TV







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	100	V		
Gate-Source Voltage		V _{GS}	± 20	V		
Continuous Drain Current (T _J = 150 °C)	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$	- I _D -	4.2 3.5 3.0 ^{a, b} 2.4 ^{a, b}	A		
Pulsed Drain Current		I _{DM}	16			
Continuous Source-Drain Diode Current	T _C = 25 °C T _A = 25 °C	- I _S -	4.0 2 ^{a, b}			
Single Avalanche Current	L = 0.1 mH	I _{AS}	6	A		
Single Avalanche Energy		E _{AS}	1.8	mJ		
Maximum Power Dissipation	$T_{C} = 25 °C$ $T_{C} = 70 °C$ $T_{A} = 25 °C$ $T_{A} = 70 °C$	P _D	4.8 3 2.4 ^{a, b} 1.5 ^{a, b}	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	42	53	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	21	26	0/11	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under steady state conditions is 85 $^{\circ}\text{C/W}.$

d. Based on T_C = 25 °C.

Symbol V _{DS} ΔV _{DS} /TJ ΔV _{GS(th} //TJ V _{GS(th})	Test Conditions $V_{GS} = 0 \text{ V}, \text{ I}_D = 250 \mu\text{A}$	Min. 100	Тур.	Max.	Unit	
$\frac{\Delta V_{DS}/T_J}{\Delta V_{GS(th)}/T_J}$		100	1			
$\frac{\Delta V_{DS}/T_J}{\Delta V_{GS(th)}/T_J}$		100				
$\Delta V_{GS(th)}/T_J$			<u> </u> !		V	
. ,	I _D = 250 μA		110		mV/°C	
V _{GS(th)}			- 7.5			
GO(ui)	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		3	V	
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
1	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
'DSS	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			10	μΑ	
I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	8			Α	
	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.7 \text{ A}$		0.124			
R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_{D} = 2.5 \text{ A}$		0.128		Ω	
9 _{fs}	V _{DS} = 10 V, I _D = 2.7 A		7		S	
I			1		<u> </u>	
C _{iss}			470		pF	
C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		50			
C _{rss}			25			
	$V_{DS} = 50$ V, $V_{GS} = 10$ V, $I_D = 2.7$ A		7.1	11		
Q _g			4.6	7	nC	
Q _{as}	$V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_{D} = 2.7 \text{ A}$		1.7			
			2			
-	f = 1 MHz		3		Ω	
			10	15		
	$V_{DD} = 50 \text{ V}, \text{ R}_{1} = 23.8 \Omega$		10	15	-	
	55 2		10	15		
	Ĵ.		10	15		
				15	ns	
	$V_{DD} = 50 \text{ V. } \text{B}_{1} = 23.8 \Omega$		-	-	-	
				-		
			-	15		
· ·		l	1			
г.	T _C = 25 °C			4		
				8	A	
	$I_{S} = 2.1 \text{ A}, V_{GS} = 0 \text{ V}$		0.8		V	
					ns	
					nC	
	$I_F = 2.1$ A, dl/dt = 100 A/µs, $T_J = 25$ °C			120		
					ns	
	I _{DSS} I _{D(on)} R _{DS(on)} g _{fs} C _{iss}	$eq:linear_line$	$\begin{array}{c c c c c c c c } & V_{DS} = 100 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_{J} = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V & 8 \\ \hline V_{GS} = 10 \ V, \ I_{D} = 2.7 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_{D} = 2.5 \ A \\ \hline g_{fs} & V_{DS} = 10 \ V, \ I_{D} = 2.7 \ A \\ \hline \hline \\ \hline$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

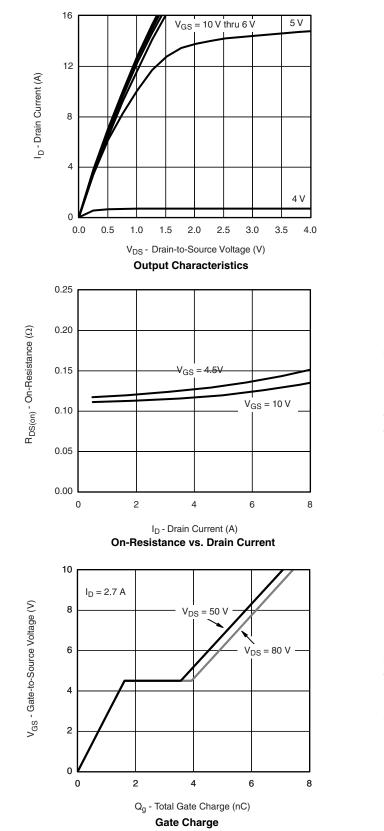
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

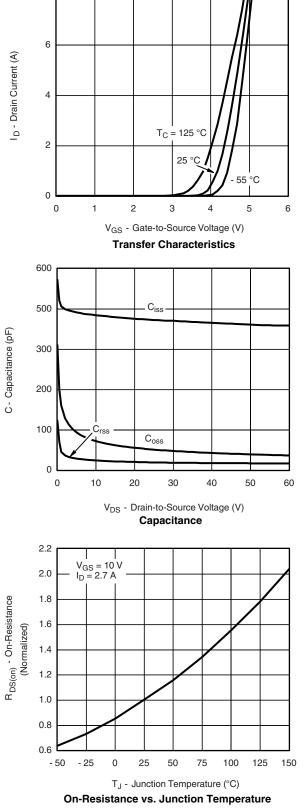
semi

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



8



8

100

10

1

Time (s) Single Pulse Power 1000

10

 $I_{D} = 2.7 \text{ A}$

2

4

0.1

100 ms

s

10 s

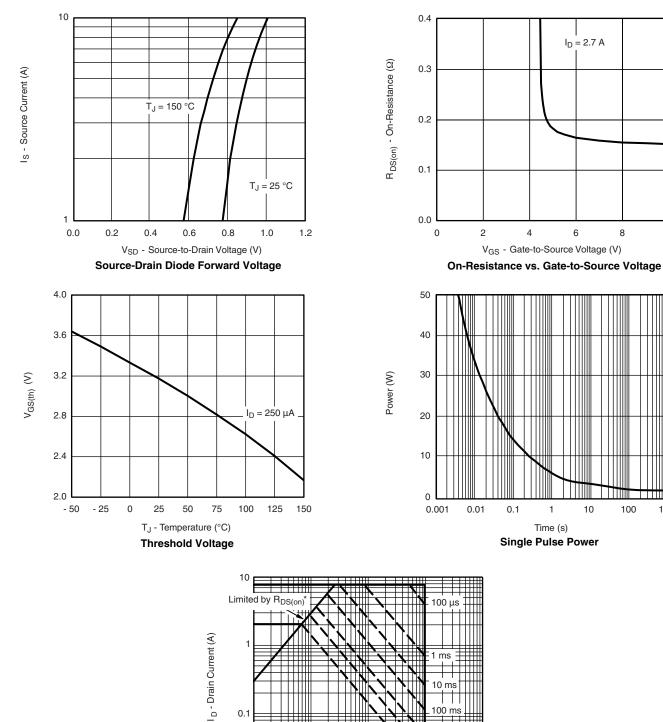
DC

1000

100

V_{GS} - Gate-to-Source Voltage (V)

6



0.1

0.01 0.1

T_A = 25 °C Single Pulse

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1

BVDSS Limited

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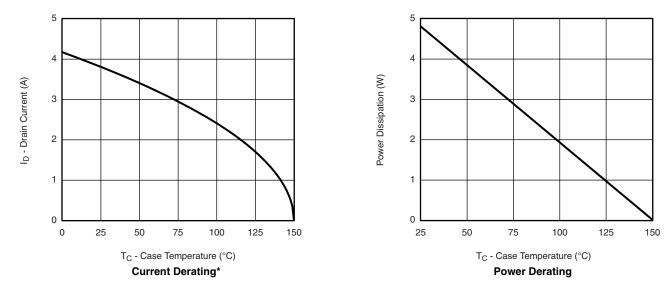
V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



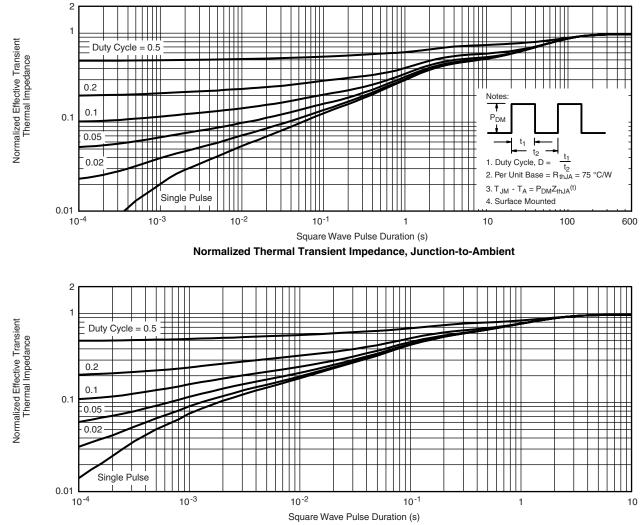


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





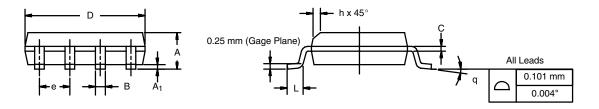
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012

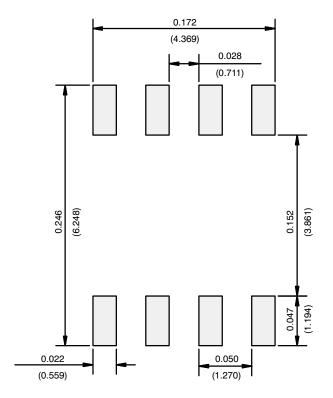




	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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